

fig.1a

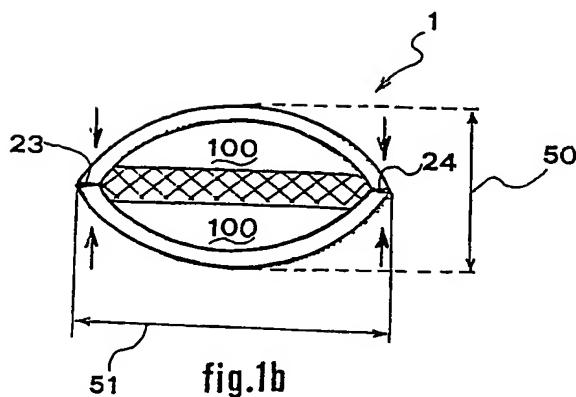


fig.1b

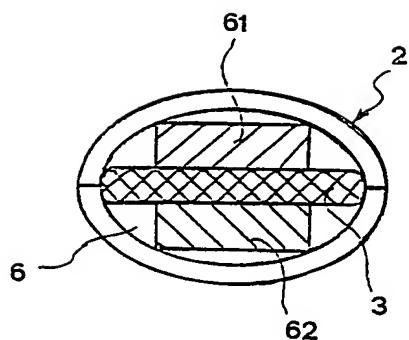


fig.2a

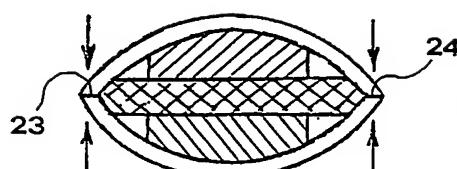


fig.2b

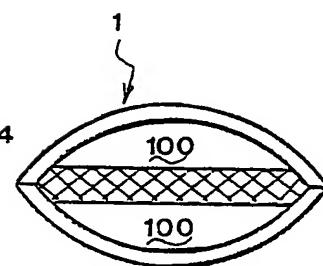


fig.2c

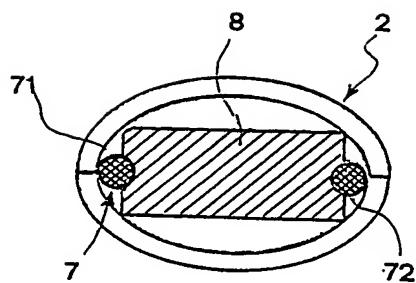


fig.3a

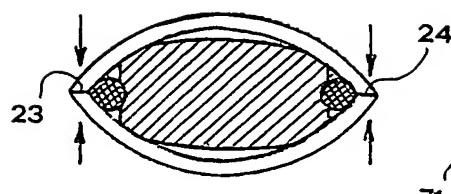


fig.3b

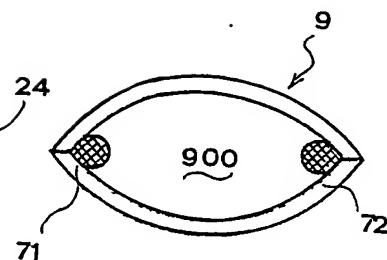


fig.3c

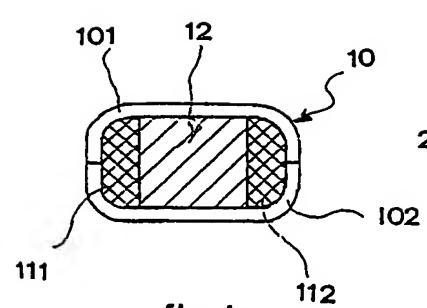


fig.4a

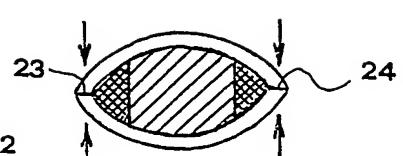


fig.4b

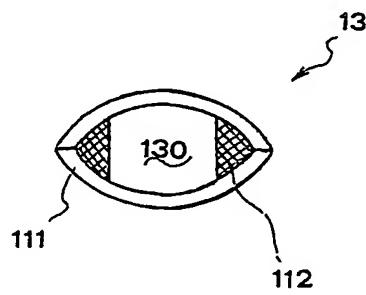


fig.4c

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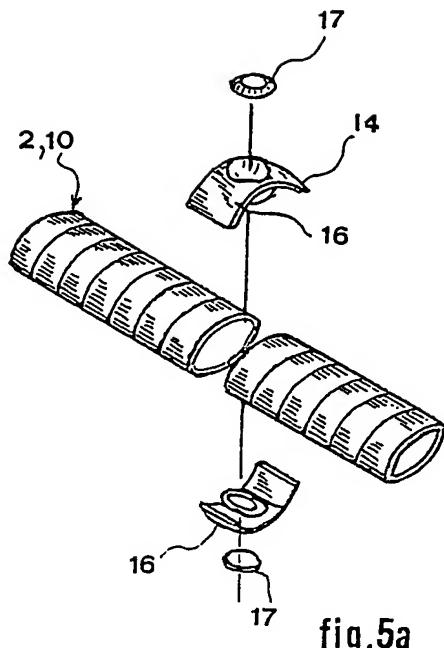


fig.5a

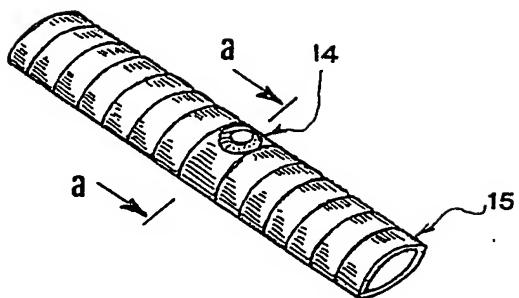


fig 5b

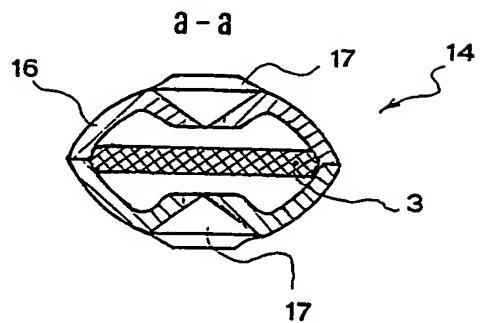


fig 6

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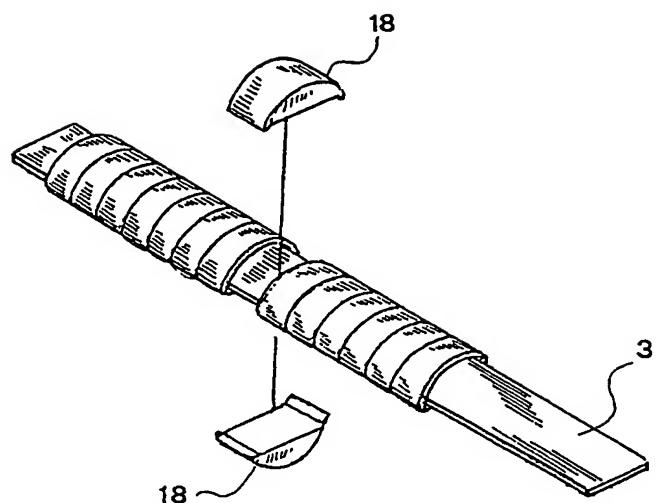


fig.7a

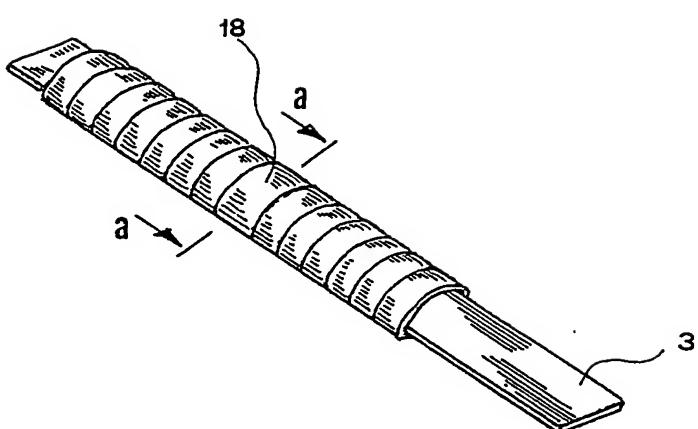


fig.7b

a-a

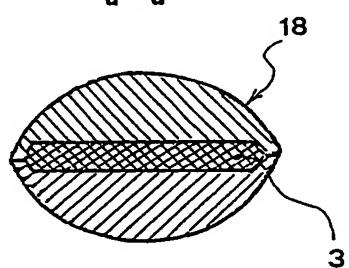


fig.8

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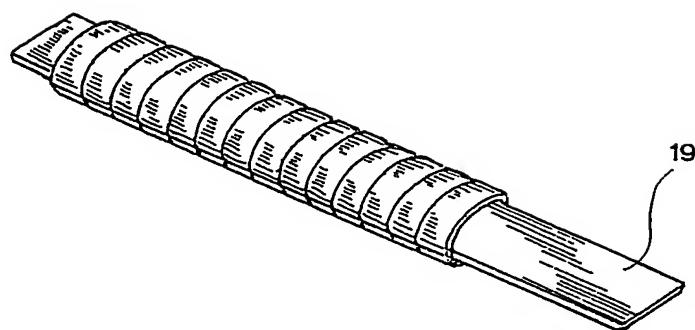


fig.9

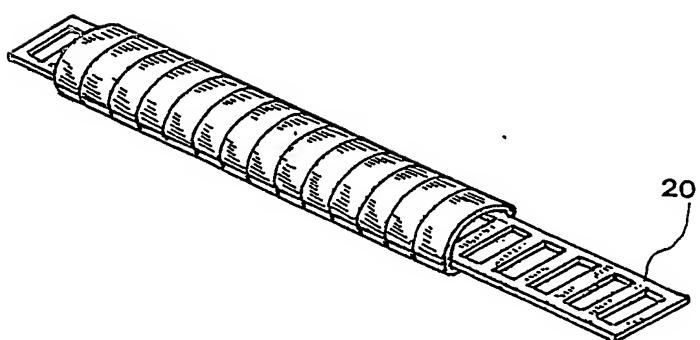


fig.10

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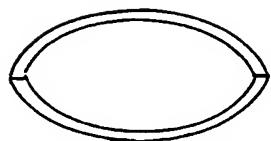


FIG.11A

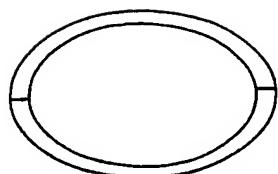


FIG.11B

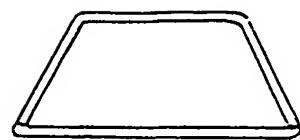


FIG.11C

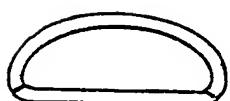


FIG.11D

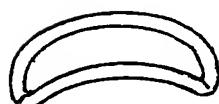


FIG.11E

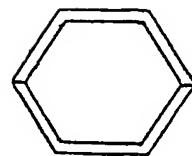


FIG.11F



FIG.11G